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جهت مشاهده قیمت، موجودی و ثبت سفارش این قطعه به وبسایت توکل الکترونیک مراجعه فرمایید.



**مشاهده قیمت و خرید**

برای خرید و مشاهده سایر محصولات کلیک کنید



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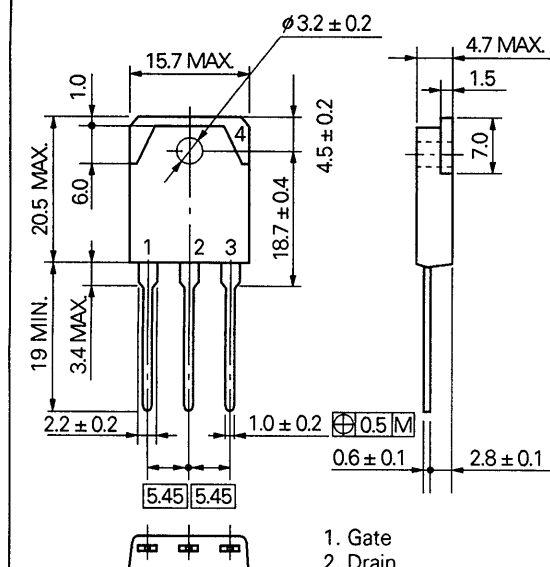
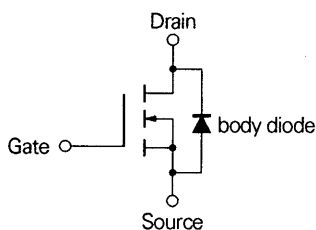
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# SWITCHING

## N-CHANNEL POWER MOS FET

### INDUSTRIAL USE

#### PACKAGE DIMENSIONS (in millimeters)



#### DESCRIPTION

The 2SK1271 is N-channel MOS Field Effect Transistor designed for high voltage switching applications.

#### FEATURES

- High Voltage Rating  $V_{DS} = 1\,400\text{ V}$
- Low On-state Resistance  
 $R_{DS(on)} = 4.0\ \Omega\text{ MAX. (}V_{GS} = 10\text{ V, }I_D = 3\text{ A)}$
- Low  $C_{iss}$   $C_{iss} = 1\,800\text{ pF TYP.}$

#### QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

#### ABSOLUTE MAXIMUM RATINGS

##### Maximum Temperatures

|                     |                |
|---------------------|----------------|
| Storage Temperature | -55 to +150 °C |
| Channel Temperature | 150 MAX. °C    |

##### Maximum Power Dissipation

|                                                  |       |
|--------------------------------------------------|-------|
| Total Power Dissipation ( $T_c = 25\text{ °C}$ ) | 240 W |
|--------------------------------------------------|-------|

##### Maximum Voltages and Currents ( $T_a = 25\text{ °C}$ )

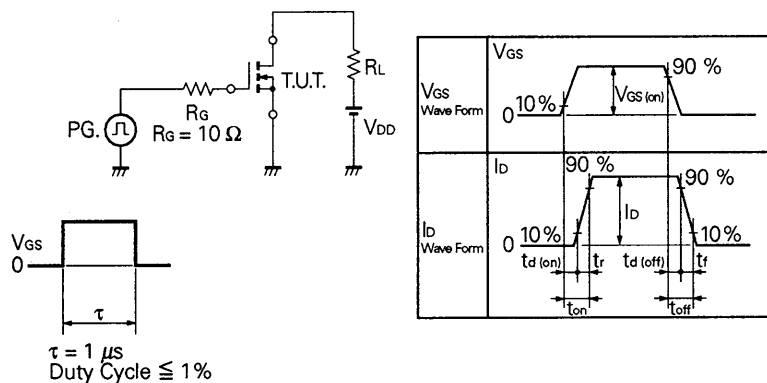
|                 |                         |         |
|-----------------|-------------------------|---------|
| $V_{DS}$        | Drain to Source Voltage | 1 400 V |
| $V_{GS}$        | Gate to Source Voltage  | ±20 V   |
| $I_{D(DC)}$     | Drain Current (DC)      | ± 5 A   |
| $I_{D(pulse)*}$ | Drain Current (pulse)   | ±10 A   |

\*  $PW \leq 10\ \mu s$ , Duty Cycle  $\leq 1\%$

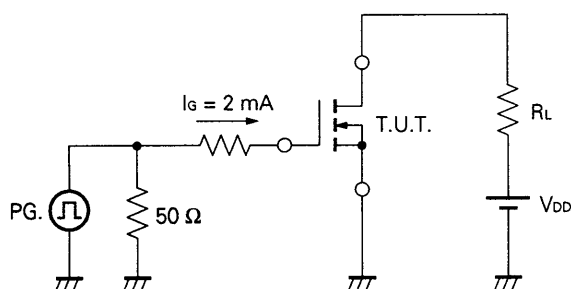
**ELECTRICAL CHARACTERISTICS ( $T_a = 25\text{ }^{\circ}\text{C}$ )**

| CHARACTERISTIC                      | SYMBOL        | MIN. | TYP.  | MAX.      | UNIT          | TEST CONDITIONS                                                                                                                |
|-------------------------------------|---------------|------|-------|-----------|---------------|--------------------------------------------------------------------------------------------------------------------------------|
| Drain to Source On-state Resistance | $R_{DS(on)}$  |      | 3.5   | 4.0       | $\Omega$      | $V_{GS} = 10\text{ V}$ , $I_D = 3\text{ A}$                                                                                    |
| Gate to Source Cutoff Voltage       | $V_{GS(off)}$ | 1.5  |       | 3.5       | V             | $V_{DS} = 10\text{ V}$ , $I_D = 1\text{ mA}$                                                                                   |
| Forward Transfer Admittance         | $ y_{fs} $    | 1.5  |       |           | S             | $V_{DS} = 20\text{ V}$ , $I_D = 3\text{ A}$                                                                                    |
| Drain Leakage Current               | $I_{DSS}$     |      |       | 100       | $\mu\text{A}$ | $V_{DS} = 1\text{ }120\text{ V}$ , $V_{GS} = 0$                                                                                |
| Gate to Source Leakage Current      | $I_{GSS}$     |      |       | $\pm 100$ | $\mu\text{A}$ | $V_{GS} = \pm 20\text{ V}$ , $V_{DS} = 0$                                                                                      |
| Input Capacitance                   | $C_{iss}$     |      | 1 800 |           | pF            | $V_{DS} = 10\text{ V}$                                                                                                         |
| Output Capacitance                  | $C_{oss}$     |      | 500   |           | pF            | $V_{GS} = 0$                                                                                                                   |
| Reverse Transfer Capacitance        | $C_{res}$     |      | 360   |           | pF            | $f = 1\text{ MHz}$                                                                                                             |
| Turn-On Delay Time                  | $t_{d(on)}$   |      | 25    |           | ns            | $V_{GS} = 10\text{ V}$<br>$V_{DD} = 150\text{ V}$<br>$I_D = 3\text{ A}$ , $R_G = 10\text{ }\Omega$<br>$R_L = 50\text{ }\Omega$ |
| Rise Time                           | $t_r$         |      | 30    |           | ns            |                                                                                                                                |
| Turn-Off Delay Time                 | $t_{d(off)}$  |      | 220   |           | ns            |                                                                                                                                |
| Fall Time                           | $t_f$         |      | 40    |           | ns            |                                                                                                                                |
| Total Gate Charge                   | $Q_G$         |      | 125   |           | nC            | $V_{GS} = 10\text{ V}$<br>$I_D = 5\text{ A}$<br>$V_{DD} = 450\text{ V}$                                                        |
| Gate to Source Charge               | $Q_{GS}$      |      | 15    |           | nC            |                                                                                                                                |
| Gate to Drain Charge                | $Q_{GD}$      |      | 70    |           | nC            |                                                                                                                                |
| Diode Forward Voltage               | $V_{F(S-D)}$  |      | 0.9   |           | V             | $I_F = 5\text{ A}$ , $V_{GS} = 0$                                                                                              |
| Reverse Recovery Time               | $t_{rr}$      |      | 1 400 |           | ns            | $I_F = 5\text{ A}$<br>$di/dt = 50\text{ A}/\mu\text{s}$                                                                        |
| Reverse Recovery Charge             | $Q_{rr}$      |      | 30    |           | $\mu\text{C}$ |                                                                                                                                |

**Test Circuit 1: Switching Time**

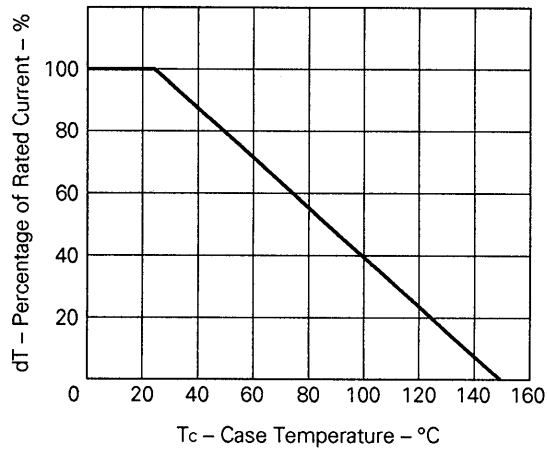


**Test Circuit 2: Gate Charge**

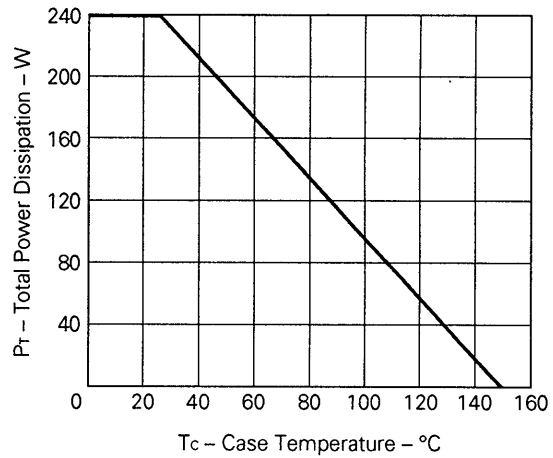


TYPICAL CHARACTERISTICS ( $T_a = 25\text{ }^{\circ}\text{C}$ )

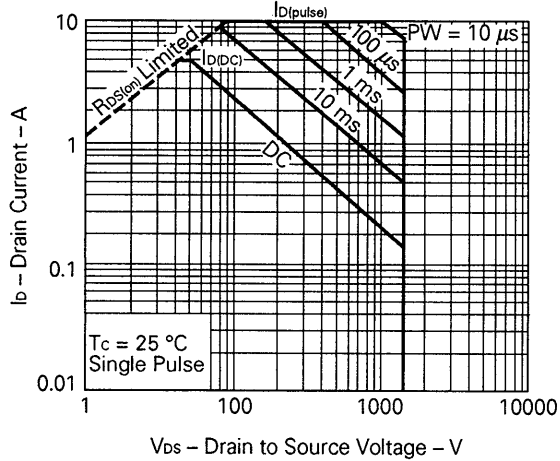
DERATING FACTOR OF FORWARD BIAS  
SAFE OPERATING AREA



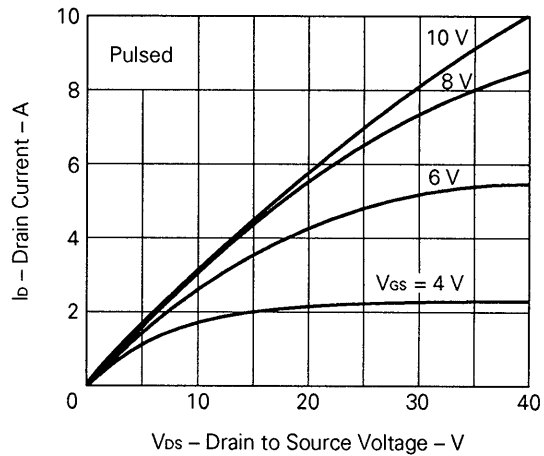
TOTAL POWER DISSIPATION vs.  
CASE TEMPERATURE



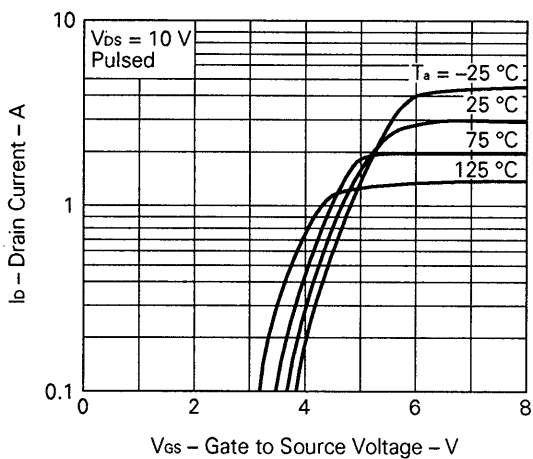
FORWARD BIAS SAFE OPERATING AREA



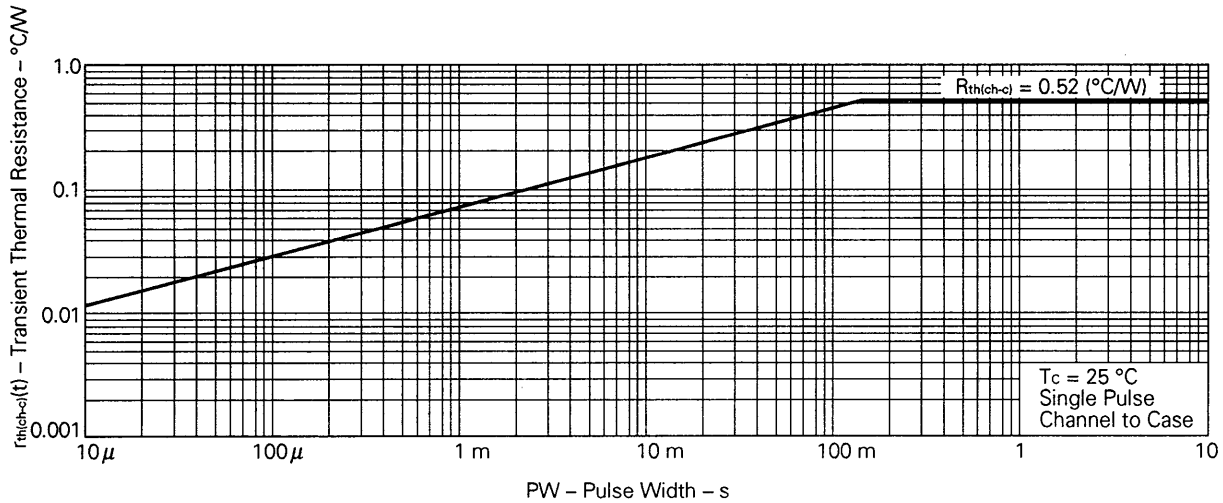
DRAIN CURRENT vs.  
DRAIN TO SOURCE VOLTAGE



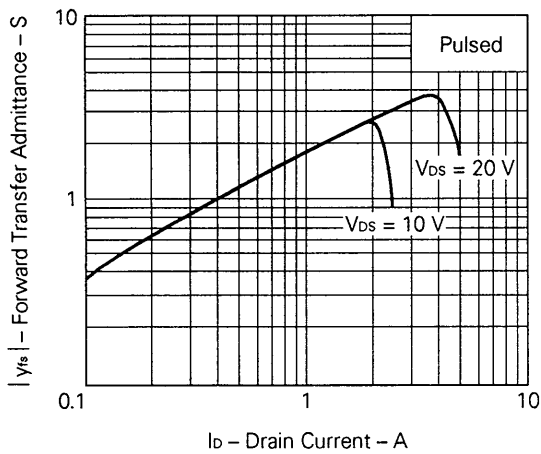
TRANSFER CHARACTERISTICS



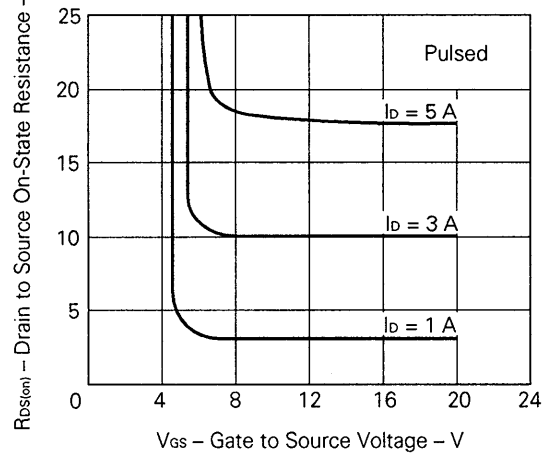
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



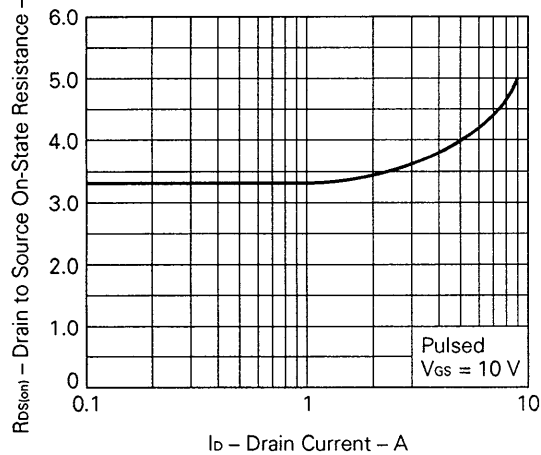
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



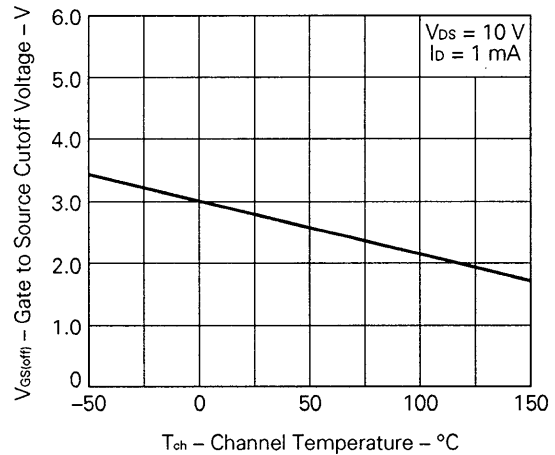
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

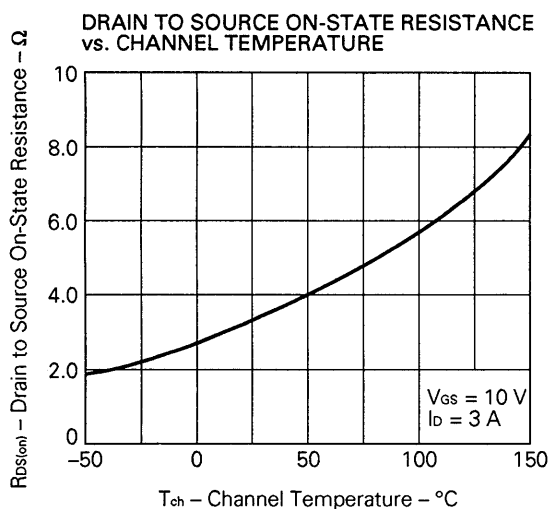
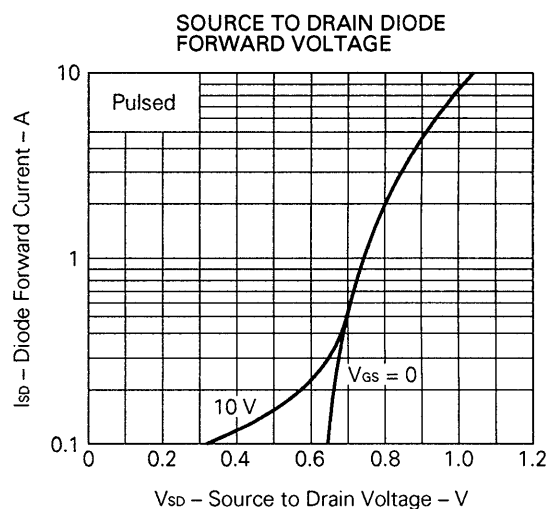
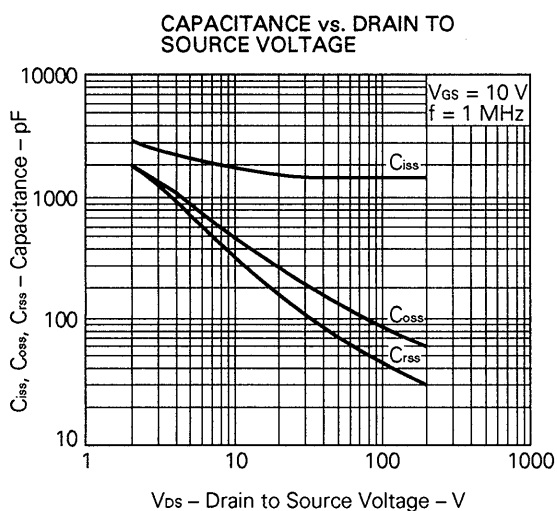
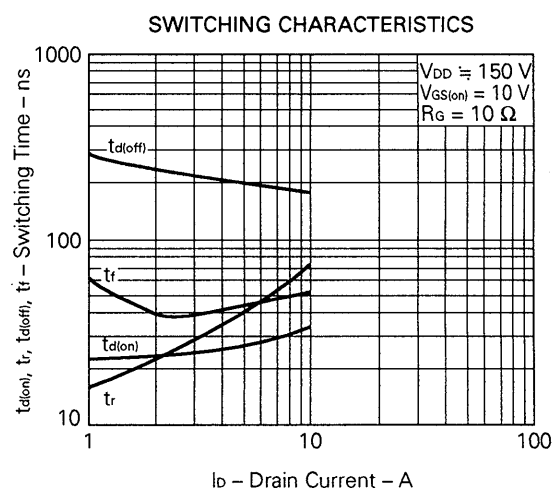
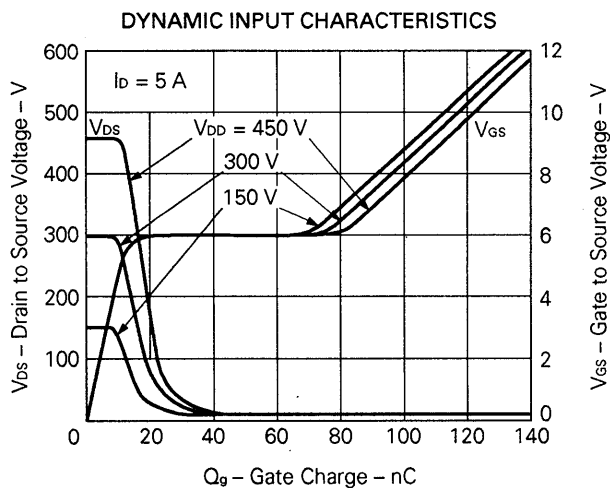
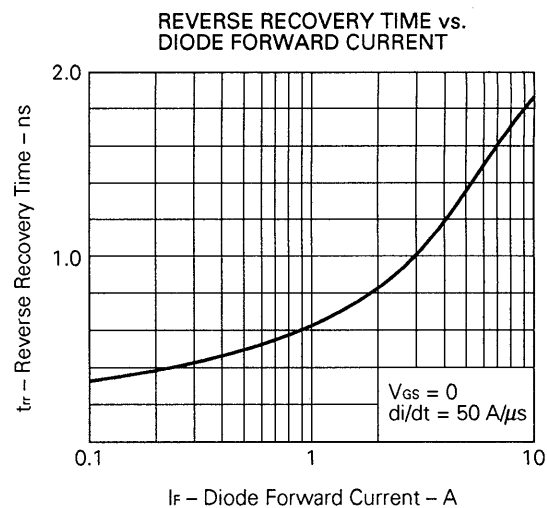


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE





**Reference**

| Application note name                            | No.      |
|--------------------------------------------------|----------|
| Safe operating area of Power MOS FET.            | TEA-1034 |
| Application circuit using Power MOS FET.         | TEA-1035 |
| Quality control of NEC semiconductors devices.   | TEI-1202 |
| Quality control guide of semiconductors devices. | MEI-1202 |
| Assembly manual of semiconductors devices.       | IEI-1207 |

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